

### General Description

This planar stripe MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for electronic ballast and switch mode power supplies.

### FEATURES

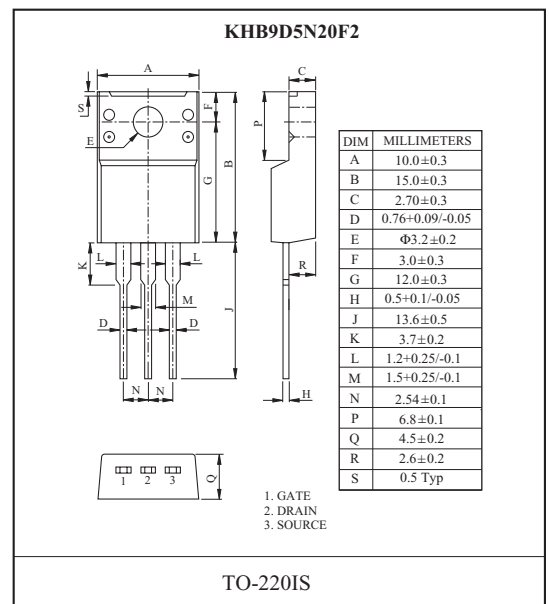
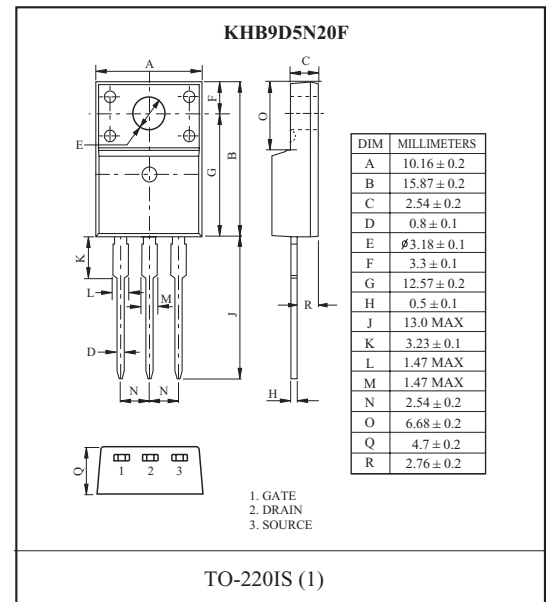
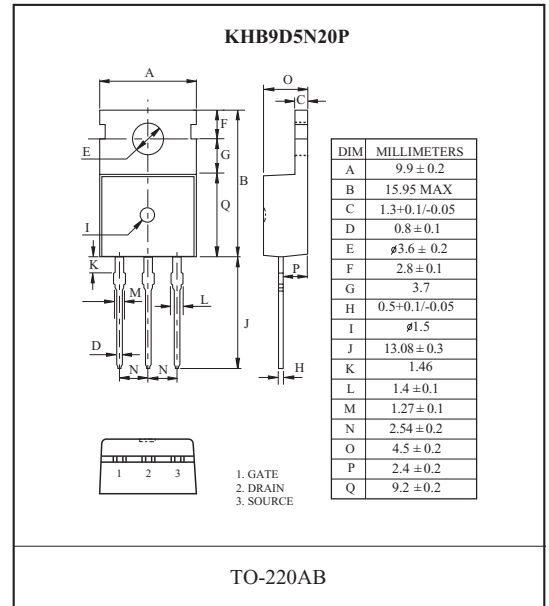
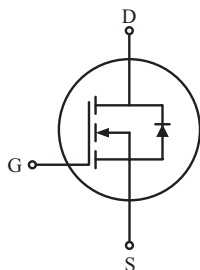
- $V_{DSS}=200V$ ,  $I_D=9.5A$
- Drain-Source ON Resistance  
:  $R_{DS(ON)}=400m$  @  $V_{GS} = 10V$
- $Q_g(\text{typ.})=18.5nC$

### MAXIMUM RATING (Ta=25 °C)

CHARACTERISTIC	SYMBOL	RATING		UNIT	
		KHB9D5N20P	KHB9D5N20F KHB9D5N20F2		
Drain-Source Voltage	$V_{DSS}$	200		V	
Gate-Source Voltage	$V_{GSS}$	$\pm 30$		V	
Drain Current	@ $T_C=25$	$I_D$	9.5	9.5*	A
	Pulsed (Note1)	$I_{DP}$	38	38*	
Single Pulsed Avalanche Energy (Note 2)	$E_{AS}$	180		mJ	
Repetitive Avalanche Energy (Note 1)	$E_{AR}$	8.7		mJ	
Peak Diode Recovery dv/dt (Note 3)	dv/dt	5.5		V/ns	
Drain Power Dissipation	$T_c=25$	$P_D$	87	40	W
	Derate above 25		0.7	0.32	
Maximum Junction Temperature	$T_j$	150			
Storage Temperature Range	$T_{stg}$	-55 150			
<b>Thermal Characteristics</b>					
Thermal Resistance, Junction-to-Case	$R_{thJC}$	1.44	3.13	/W	
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	62.5	62.5	/W	

\* : Drain current limited by maximum junction temperature.

### PIN CONNECTION



# KHB9D5N20P/F/F2

## ELECTRICAL CHARACTERISTICS (Ta=25 °C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=250\ \mu A, V_{GS}=0V$	200	-	-	V
Breakdown Voltage Temperature Coefficient	$BV_{DSS}/T_j$	$I_D=250\ \mu A$ , Referenced to 25	-	0.19	-	V/°C
Gate Threshold Voltage	$V_{th}$	$V_{DS}=V_{GS}, I_D=250\ \mu A$	2.0	-	4.0	V
Drain Cut-off Current	$I_{DSS}$	$V_{DS}=200V, V_{GS}=0V$ ,	-	-	1	$\mu A$
Gate Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30V, V_{DS}=0V$	-	-	$\pm 100$	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=4.75A$	-	345	400	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS}=40V, I_D=4.75A$ (Note4)	-	6.7	-	S
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=160V, I_D=9.5A$ $V_{GS}=10V$ (Note4, 5)	-	18.5	23	nC
Gate-Source Charge	$Q_{gs}$		-	2.7	-	
Gate-Drain Charge	$Q_{gd}$		-	9	-	
Turn-on Delay time	$t_{d(on)}$	$V_{DD}=100V, R_G=25\ \Omega$ $I_D=9.5A$ (Note4, 5)	-	11	32	ns
Turn-on Rise time	$t_r$		-	62	135	
Turn-off Delay time	$t_{d(off)}$		-	46	102	
Turn-off Fall time	$t_f$		-	80	170	
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	-	387	503	pF
Output Capacitance	$C_{oss}$		-	96	125	
Reverse Transfer Capacitance	$C_{rss}$		-	34	45	
<b>Source-Drain Diode Ratings</b>						
Continuous Source Current	$I_S$	$V_{GS}<V_{th}$	-	-	9.5	A
Pulsed Source Current	$I_{SP}$		-	-	38	
Diode Forward Voltage	$V_{SD}$	$I_S=9.5A, V_{GS}=0V$	-	-	1.5	V
Reverse Recovery Time	$t_{rr}$	$I_S=9.5A, V_{GS}=0V$ ,	-	130	-	ns
Reverse Recovery Charge	$Q_{rr}$	$dI_S/dt=100A/\mu s$ (Note 4)	-	0.6	-	$\mu C$

Note 1) Repetivity rating : Pulse width limited by junction temperature.

Note 2)  $L=3mH, I_{AS}=9.5A, V_{DD}=50V, R_G=25\ \Omega$ , Starting  $T_j=25\ ^\circ C$ .

Note 3)  $I_S=9.5A, dI/dt=300A/\mu s, V_{DD}=BV_{DSS}$ , Starting  $T_j=25\ ^\circ C$ .

Note 4) Pulse Test : Pulse width  $300\ \mu s$ , Duty Cycle 2%.

Note 5) Essentially independent of operating temperature.

# KHB9D5N20P/F/F2

Fig1.  $I_D - V_{DS}$

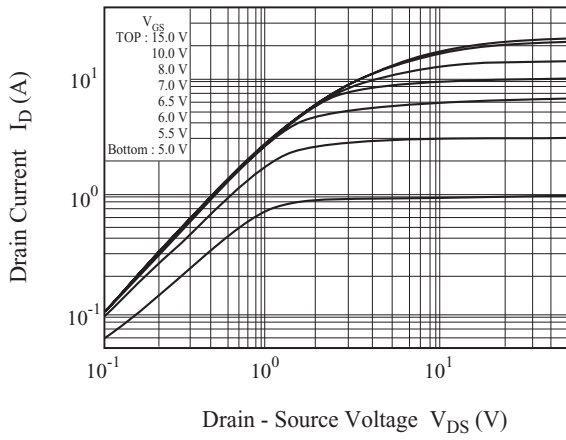


Fig2.  $I_D - V_{GS}$

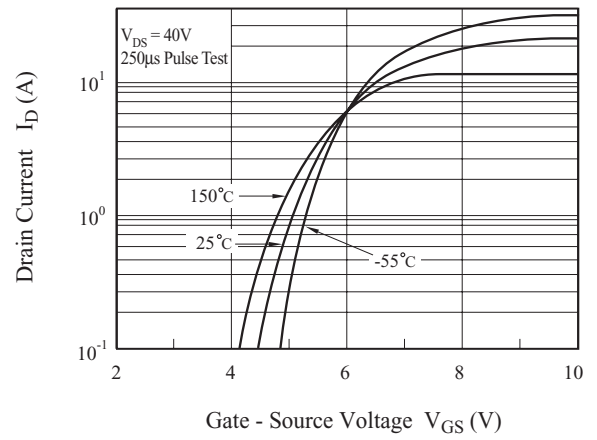


Fig4.  $BV_{DSS} - T_j$

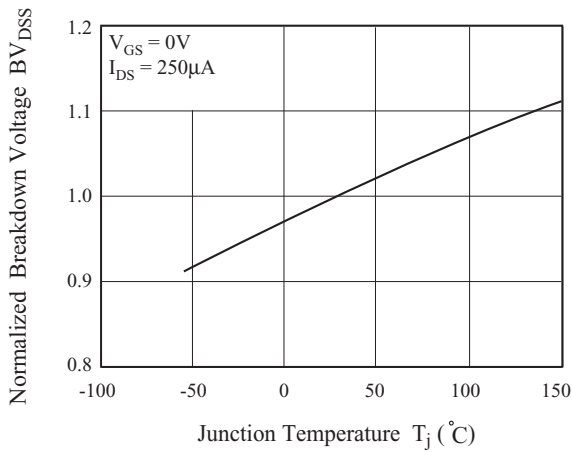


Fig5.  $R_{DS(ON)} - I_D$

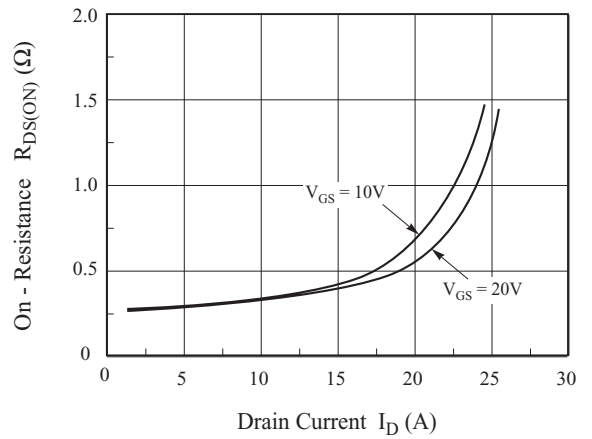


Fig6.  $I_S - V_{SD}$

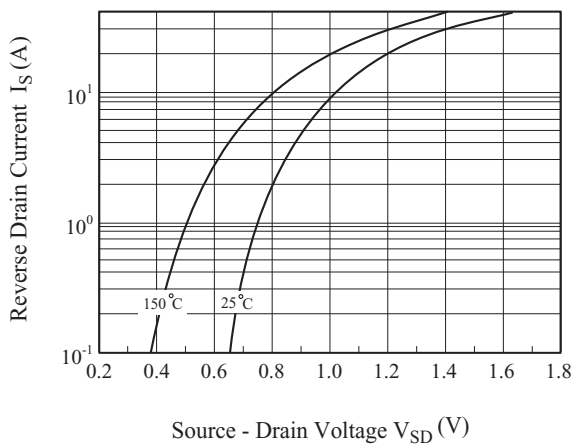
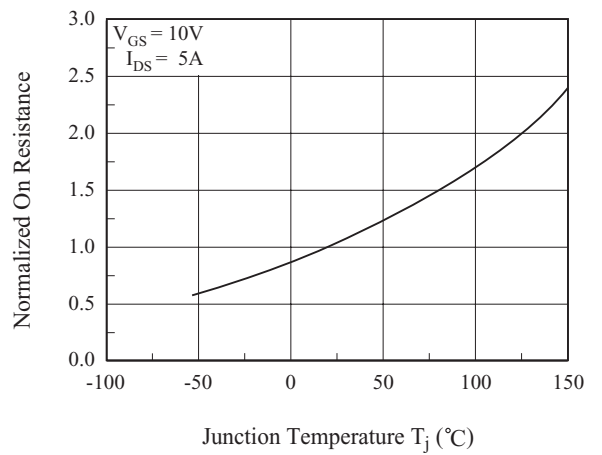


Fig6.  $R_{DS(ON)} - T_j$



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Fig7. C - V<sub>DS</sub>

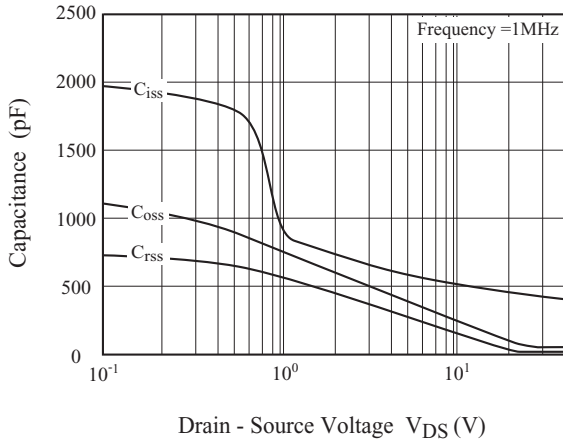


Fig8. Q<sub>g</sub>- V<sub>GS</sub>

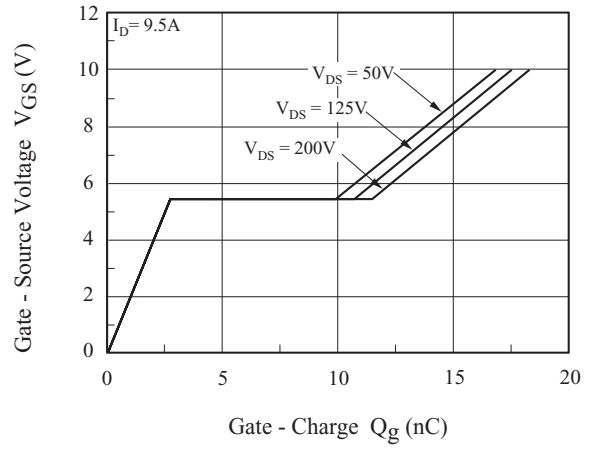


Fig9. Safe Operation Area

(KHB9D5N20P)

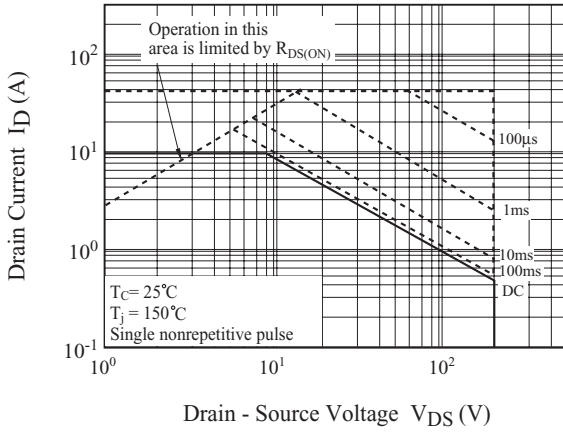


Fig10. Safe Operation Area

(KHB9D5N20F, KHB9D5N20F2)

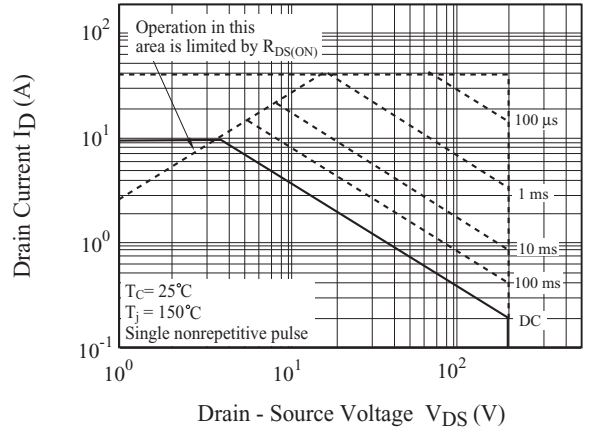
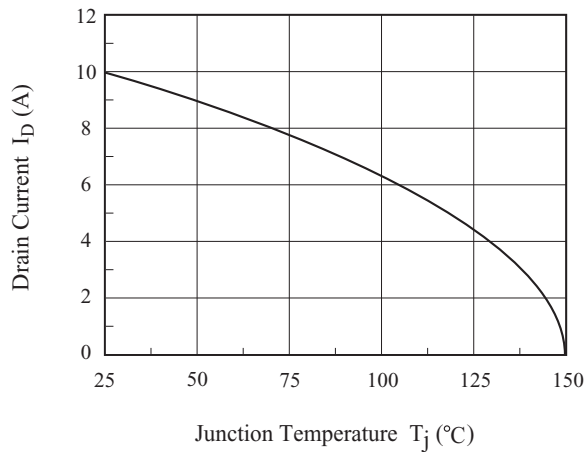


Fig11. I<sub>D</sub> - T<sub>j</sub>



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Fig12. Transient Thermal Response Curve

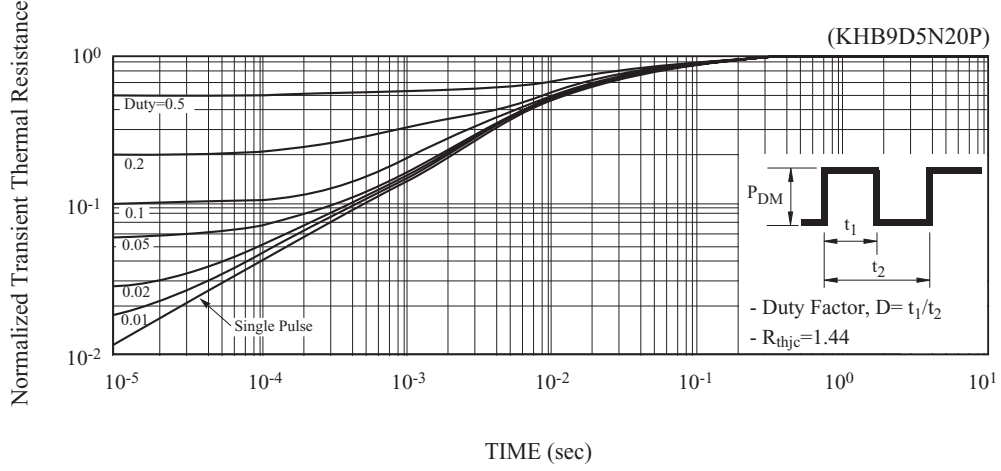
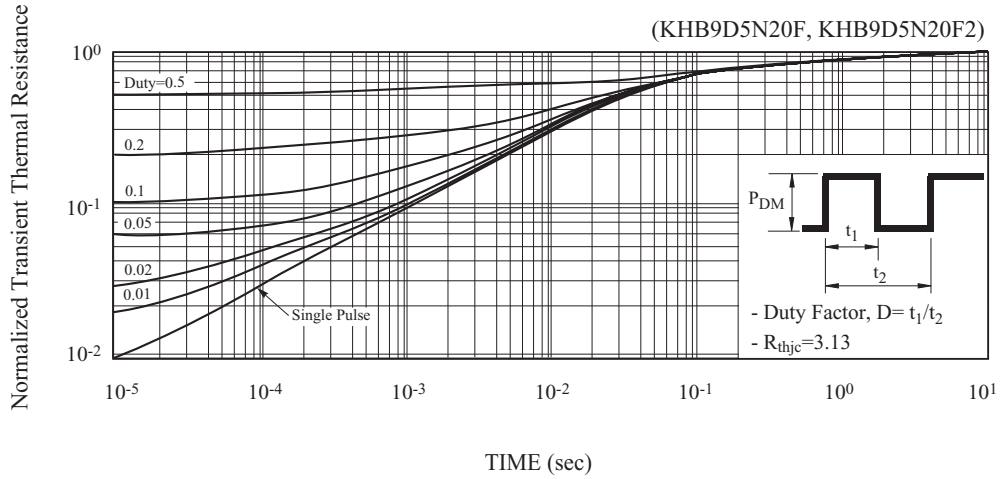


Fig13. Transient Thermal Response Curve



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Fig14. Gate Charge

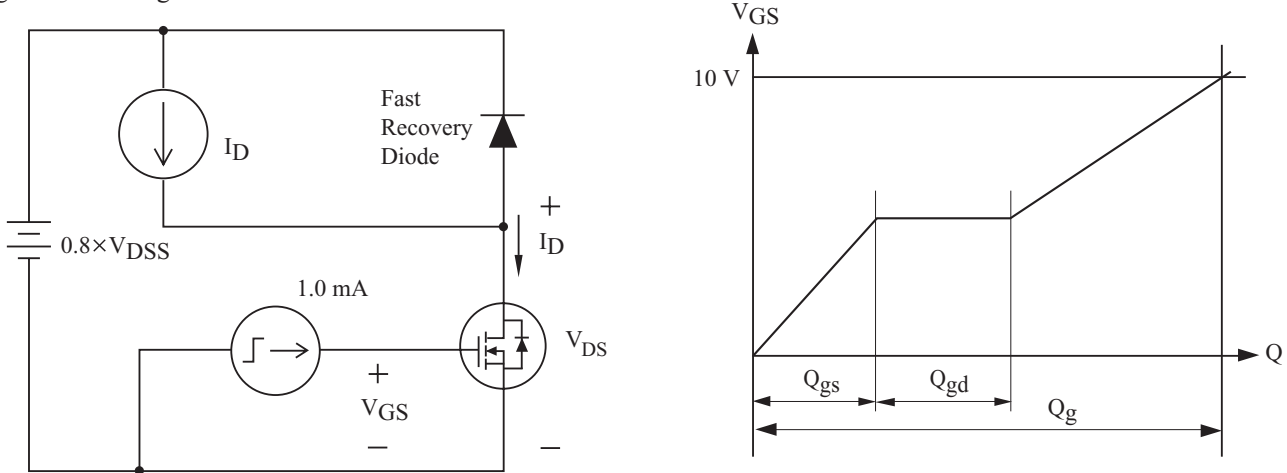


Fig15. Single Pulsed Avalanche Energy

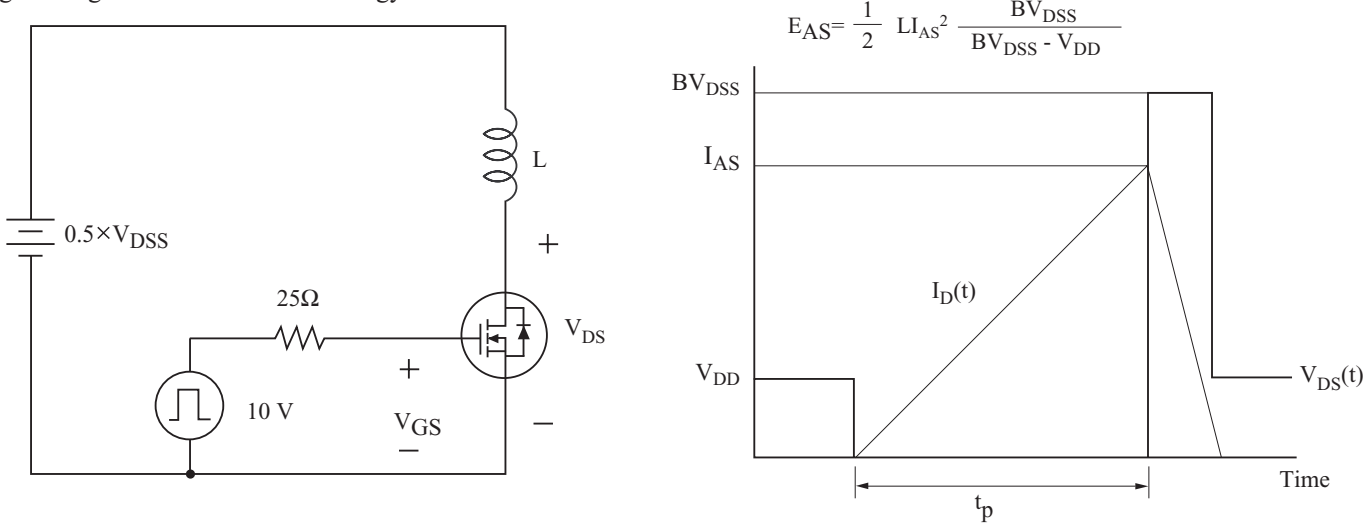


Fig16. Resistive Load Switching

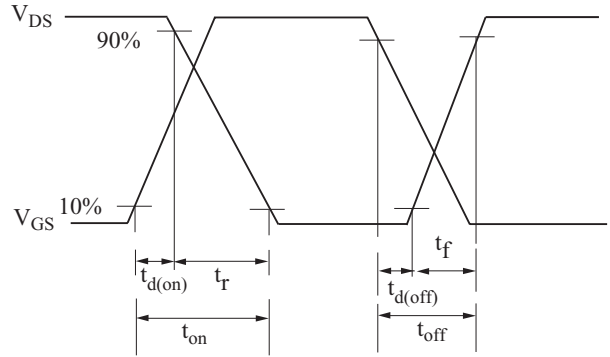
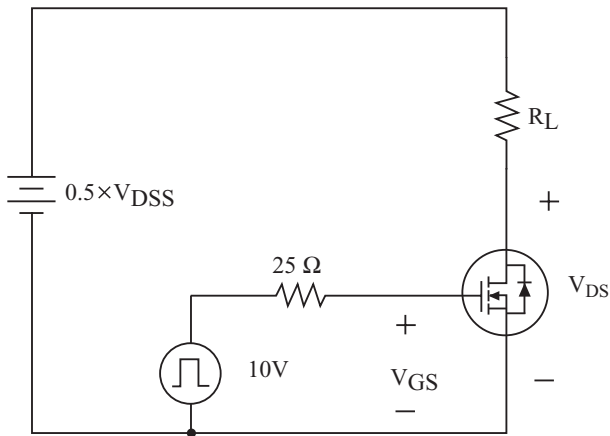


Fig17. Source - Drain Diode Reverse Recovery and  $dv/dt$

